

**R6046FNZ** 

Nch 600V 46A Power MOSFET

Datasheet

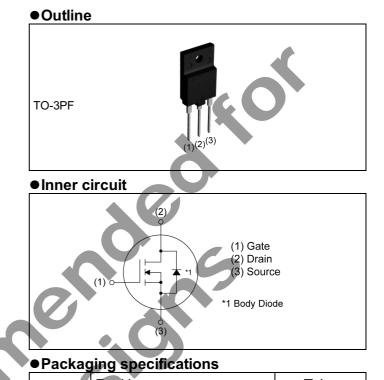
V <sub>DSS</sub>	600V
R <sub>DS(on)</sub> (Max.)	93mΩ
Ι <sub>D</sub>	±46A
P <sub>D</sub>	130W

## Features

- 1) Fast reverse recovery time (trr).
- 2) Low on-resistance.
- 3) Fast switching speed.
- 4) Gate-source voltage ( $V_{GSS}$ ) guaranteed to

be ±30V.

- 5) Drive circuits can be simple.
- 6) Pb-free lead plating ; RoHS compliant



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## • Absolute maximum ratings (T<sub>a</sub> = 25°C , unless otherwise specified)

Paramete	r	Symbol	Value	Unit
Drain - Source voltage		V <sub>DSS</sub>	600	V
	T <sub>C</sub> = 25°C	۱ <sub>D</sub> *1	±46	А
Continuous drain current	T <sub>C</sub> = 100°C	۱ <sub>D</sub> *1	±21.3	Α
Pulsed drain current		$I_{DP}^{*2}$	±115	Α
Gate - Source voltage		V <sub>GSS</sub>	±30	V
Avalanche current, single pulse		$I_{AS}^{*3}$	23	Α
Avalanche energy, single pulse		$E_{AS}^{*3}$	142	mJ
Avalanche energy, repetitive		E <sub>AR</sub> <sup>*4</sup>	10	mJ
Power dissipation $(T_c = 25^{\circ}C)$		P <sub>D</sub>	130	W
Junction temperature		Tj	150	°C
Operating junction and storage t	emperature range	T <sub>stg</sub>	-55 to +150	°C
Reverse diode dv/dt		dv/dt	15	V/ns

## •Absolute maximum ratings

Parameter		S	ymbol	C	onditions		Values	Unit
Drain - Source voltage slope			dv/dt	$V_{DS} = 480V, I_D = 46A$ $T_j = 125^{\circ}C$		50	V/ns	
●Thermal resistance								
Parameter			Syn	ıbol	Min.	Values Typ.	Max.	Unit
Thermal resistance, junction - cas		R <sub>t</sub>	ŋJC	- (	-	0.96	°C/W	
Thermal resistance, junction - am	bient		R <sub>t</sub>	hJA		-	40	°C/W
Soldering temperature, wavesold	ering for 10s		Ts	old	9	-	265	°C
•Electrical characteristics (T <sub>a</sub>		5				Values		
Parameter	Symbol	Ċ	Condition		Min.	Тур.	Max.	Unit
Drain - Source breakdown voltage	V <sub>(BR)DSS</sub>	√ <sub>GS</sub> = 0`	V, I <sub>D</sub> = 1r	nA	600	-	-	V
Drain - Source avalanche breakdown voltage	V <sub>(BR)DS</sub>	V <sub>GS</sub> = 0	V, I <sub>D</sub> = 23	BA	-	700	-	V
Zero gate voltage drain current	I <sub>DSS</sub> -	V <sub>DS</sub> = 60 T <sub>j</sub> = 25° T <sub>j</sub> = 128		= 0V	-	-	0.1 100	mA
Gate - Source leakage current	I <sub>GSS</sub> V	√ <sub>GS</sub> = ±3	30V, V <sub>DS</sub>	= 0V	-	-	±100	nA
Gate threshold voltage	V <sub>GS(th)</sub> V	√ <sub>DS</sub> = 10	0V, I <sub>D</sub> = 1	mA	3	-	5	V
Static drain - source on - state resistance	R <sub>DS(on)</sub> *6	V <sub>GS</sub> = 10 T <sub>j</sub> = 25° T <sub>j</sub> = 128		23A	-	75 160	93 -	mΩ
Gate resistance	R <sub>G</sub> f	= 1MHz			1	1.8		Ω

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## •Electrical characteristics (T<sub>a</sub> = 25°C)

Deremeter	Cumphal	Conditions	Values			l Init	
Parameter	Symbol Conditions		Min.	Тур.	Max.	Unit	
Forward Transfer Admittance	Y <sub>fs</sub>  * <sup>6</sup>	V <sub>DS</sub> = 10V, I <sub>D</sub> = 23A	21	35	-	S	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0V	-	6100			
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = 25V	-	3600		pF	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1MHz	-	90	-		
Effective output capacitance, energy related	C <sub>o(er)</sub>	V <sub>GS</sub> = 0V,		175	-		
Effective output capacitance, time related	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0V to 480V		596	-	pF	
Turn - on delay time	t <sub>d(on)</sub> *6	$V_{DD} \simeq 300 V$ , $V_{GS} = 10 V$	-	77	-		
Rise time	t <sub>r</sub> *6	I <sub>D</sub> = 23A		150	-		
Turn - off delay time	t <sub>d(off)</sub> *6	R <sub>L</sub> ≃ 13Ω		230	460	ns	
Fall time	t <sub>f</sub> *6	R <sub>G</sub> = 10Ω		80	160		

# • Gate charge characteristics (T<sub>a</sub> = 25°C

Parameter	Symbol Conditions		Values			Unit
Parameter			Min.	Тур.	Max.	Unit
Total gate charge	$Q_g^{*6}$	V <sub>DD</sub> ≃ 300V	-	150	-	
Gate - Source charge	Q <sub>gs</sub> *6	I <sub>D</sub> = 46A	-	40	-	nC
Gate - Drain charge	Q <sub>gd</sub> *6	V <sub>GS</sub> = 10V	-	60	-	
Gate plateau voltage	V <sub>(plateau)</sub>	$V_{DD} \simeq 300$ V, I <sub>D</sub> = 46A	-	7.1	-	V

\*1 Limited only by maximum temperature allowed.

\*2 Pw  $\leq$  10µs, Duty cycle  $\leq$  1%

\*3 L  $\simeq$  500µH, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 $\Omega$ , starting T<sub>j</sub> = 25°C

- \*4 L  $\simeq$  500µH, V<sub>DD</sub> = 50V, R<sub>G</sub> = 25 $\Omega$ , starting T<sub>j</sub> = 25°C, f = 10kHz
- \*5 Reference measurement circuits Fig.5-1.

\*6 Pulsed



# •Body diode electrical characteristics (Source-Drain) (T<sub>a</sub> = 25°C)

Symbol	Conditions	Values			Unit
Symbol	Conditions	Min.	Тур.	Max.	Unit
۱ <sub>S</sub> *1	T - 25°0	-	-	46	А
ا <sub>SP</sub> *2	$T_{\rm C} = 25 {\rm C}$	-	-	115	A
$V_{SD}^{*6}$	V <sub>GS</sub> = 0V, I <sub>S</sub> = 46A	-	-	1.5	V
t <sub>rr</sub> *6		-	154	-	ns
Q <sub>rr</sub> *6	U U		0.74	-	μC
<sup>*6</sup>			9.6	-	А
di <sub>rr</sub> /dt	T <sub>j</sub> = 25°C	).	1200	-	A/µs
	I <sub>SP</sub> *2 V <sub>SD</sub> *6 t <sub>rr</sub> *6 Q <sub>rr</sub> *6 I <sub>rrm</sub> *6	$ \begin{array}{c} I_{S}^{*1} \\ I_{SP}^{*2} \\ \hline V_{SD}^{*6} \\ \hline V_{GS} = 0V, I_{S} = 46A \\ \hline t_{rr}^{*6} \\ \hline Q_{rr}^{*6} \\ \hline I_{rrm}^{*6} \\ \hline \end{array} $	J       Min. $I_S^{*1}$ $T_C = 25^{\circ}C$ - $I_{SP}^{*2}$ $T_C = 25^{\circ}C$ - $V_{SD}^{*6}$ $V_{GS} = 0V, I_S = 46A$ - $t_{rr}^{*6}$ $I_S = 46A$ - $Q_{rr}^{*6}$ $I_S = 46A$ - $I_{rrm}^{*6}$ $I_S = 46A$ -	Symbol         Conditions         Min.         Typ. $I_S^{*1}$ $T_C = 25^{\circ}C$ -         - $I_{SP}^{*2}$ $T_C = 25^{\circ}C$ -         - $V_{SD}^{*6}$ $V_{GS} = 0V, I_S = 46A$ -         - $t_{rr}^{*6}$ $I_S = 46A$ -         - $I_{rrm}^{*6}$ $I_S = 46A$ -         0.74 $I_{rrm}^{*6}$ $I_S = 46A$ -         9.6	Symbol         Conditions         Min.         Typ.         Max. $I_S^{*1}$ $T_C = 25^{\circ}C$ -         -         46 $I_{SP}^{*2}$ $T_C = 25^{\circ}C$ -         -         115 $V_{SD}^{*6}$ $V_{GS} = 0V, I_S = 46A$ -         -         1.5 $t_{rr}^{*6}$ $I_S = 46A$ -         -         154         - $Q_{rr}^{*6}$ $I_S = 46A$ -         0.74         -         - $I_{rrm}^{*6}$ -         9.6         -         -         -         -

## Typical transient thermal characteristic

●Typical transier	nt thermal characte	ristics	0	5	
Symbol	Value	Unit	Symbol	Value	Unit
R <sub>th1</sub>	0.0341		C <sub>th1</sub>	0.0112	
R <sub>th2</sub>	0.266	к/w	C <sub>th2</sub>	0.133	Ws/K
R <sub>th3</sub>	1.24		C <sub>th3</sub>	1.27	
	η	Rth1	<u>-</u>	Rth,n	T case
PD 10	) Ct	h1 (	Cth2	Cth,n	





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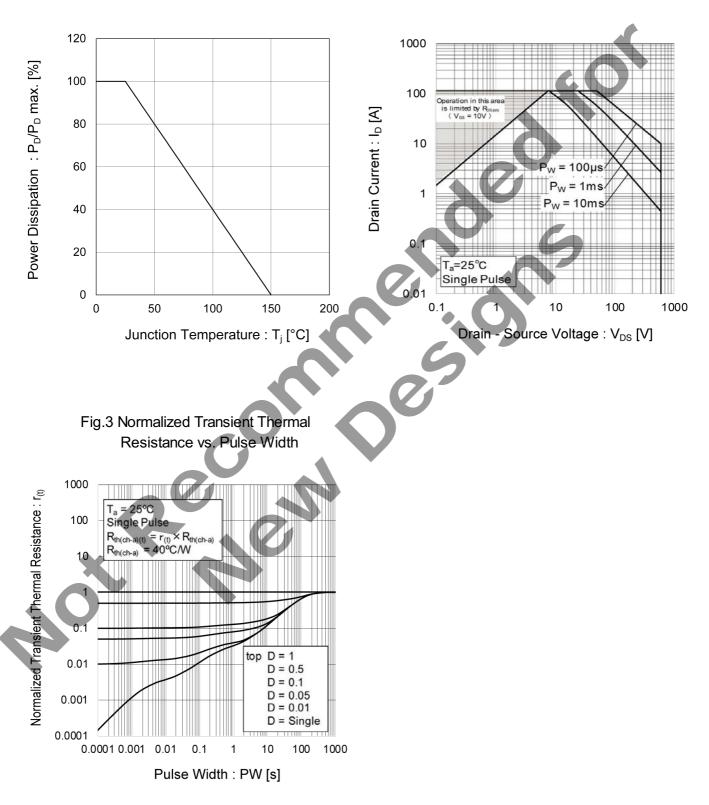
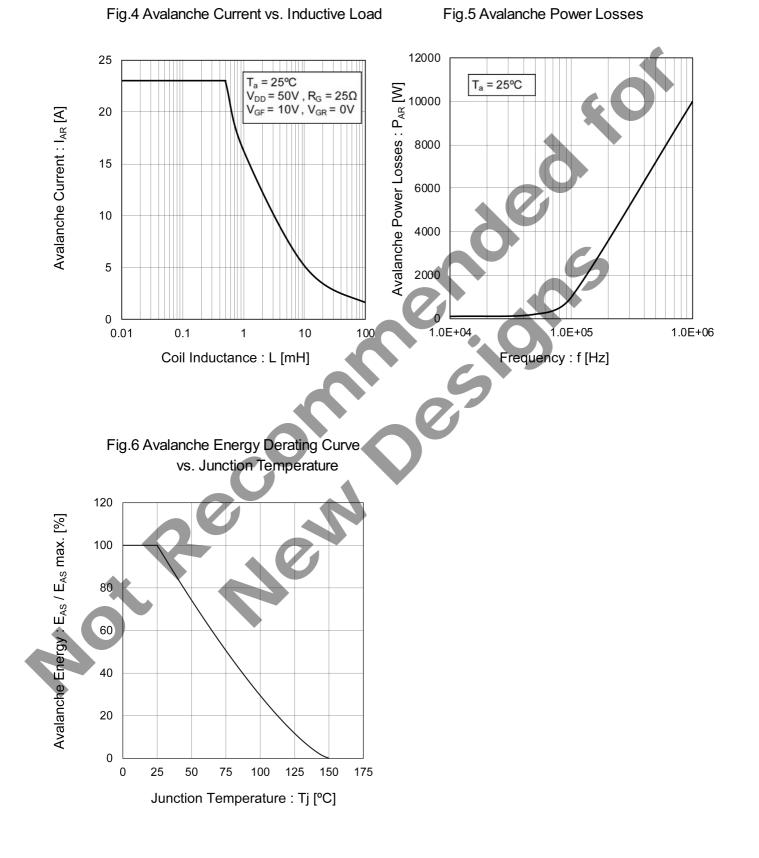


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area







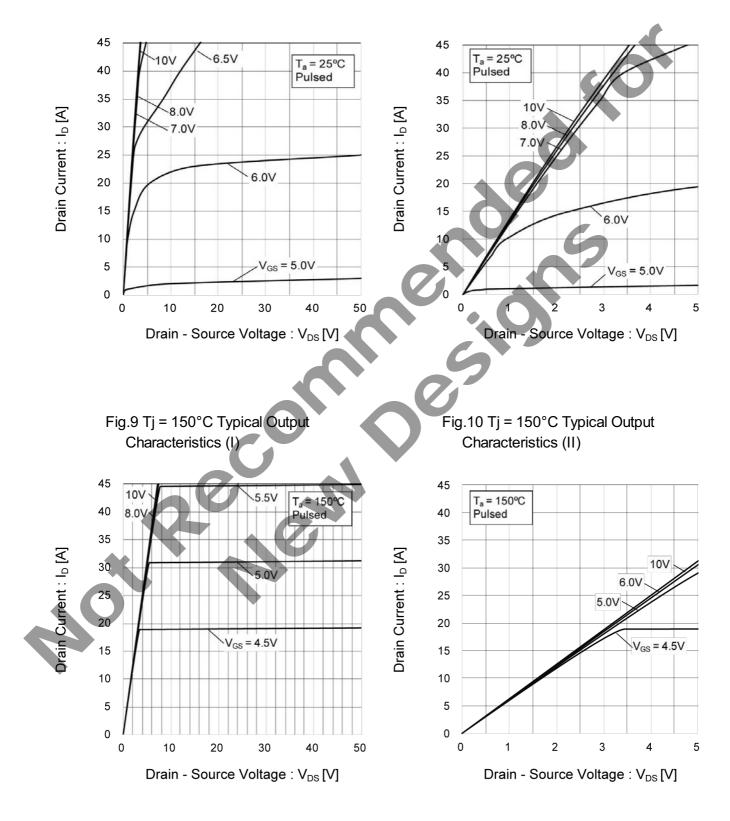
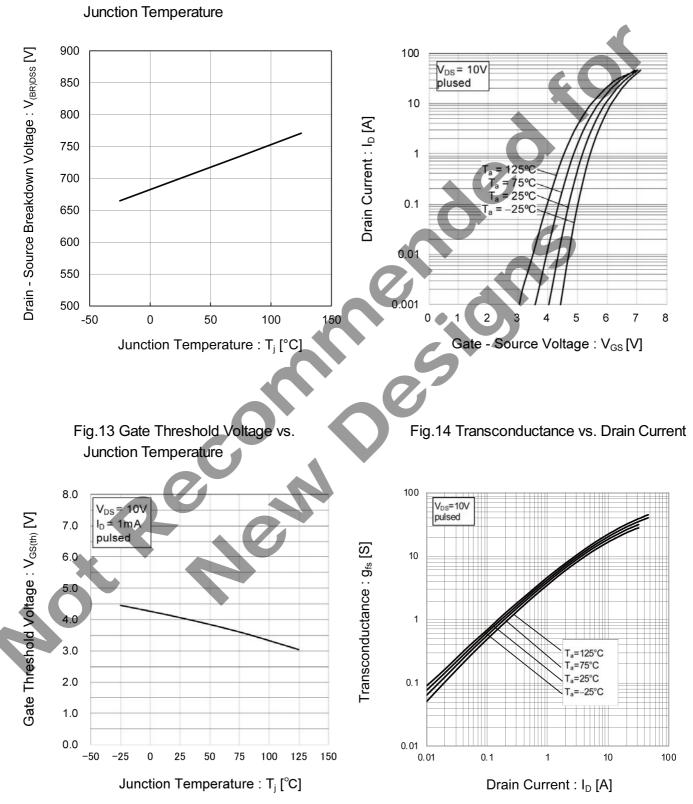
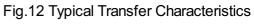


Fig.7 Typical Output Characteristics(I)

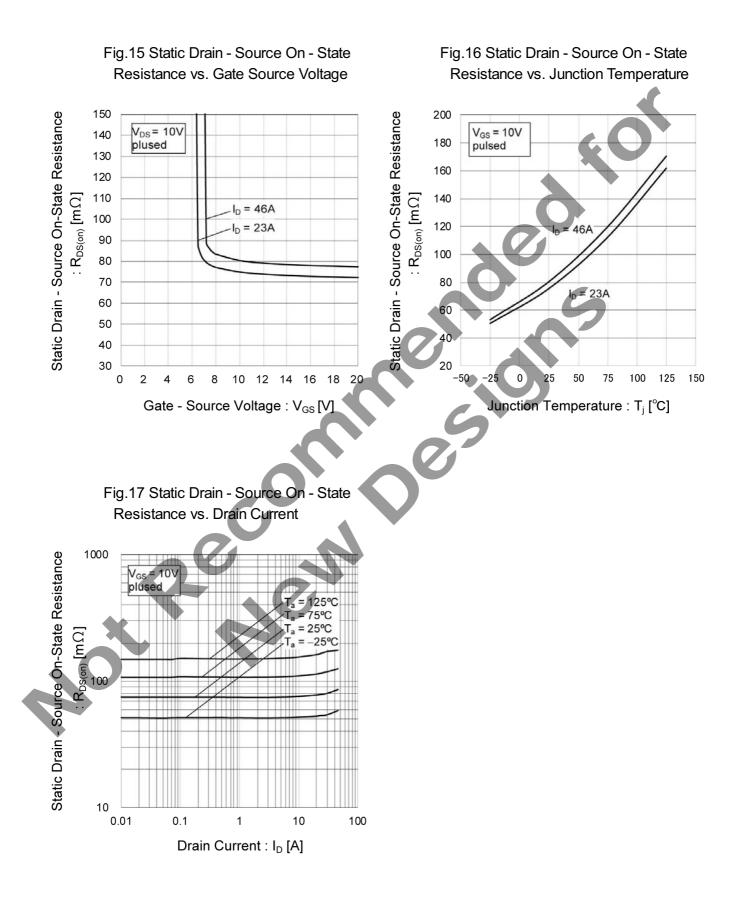
## Fig.8 Typical Output Characteristics(II)





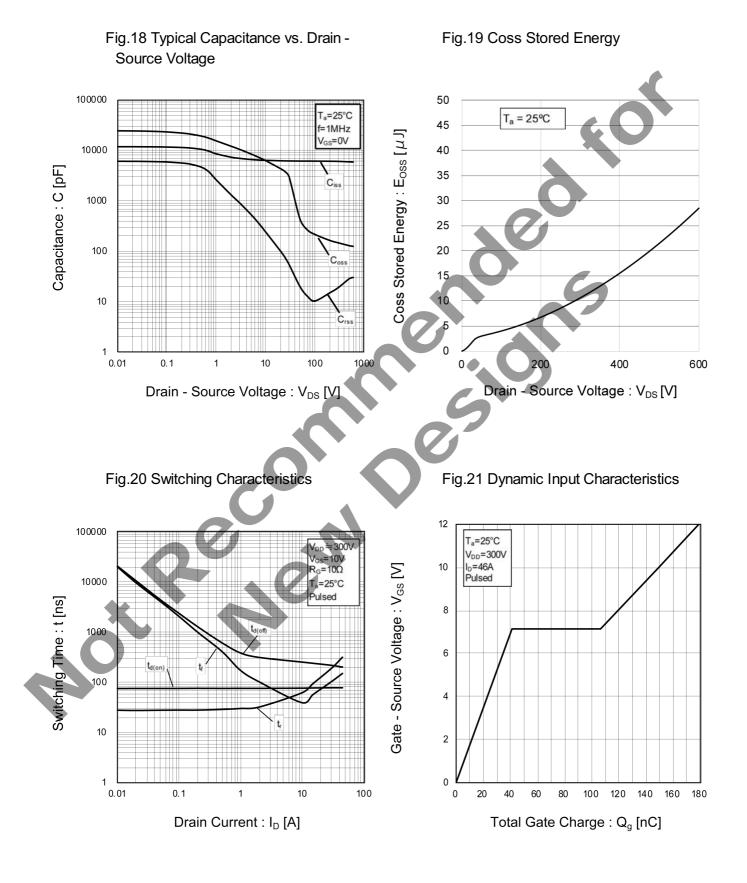




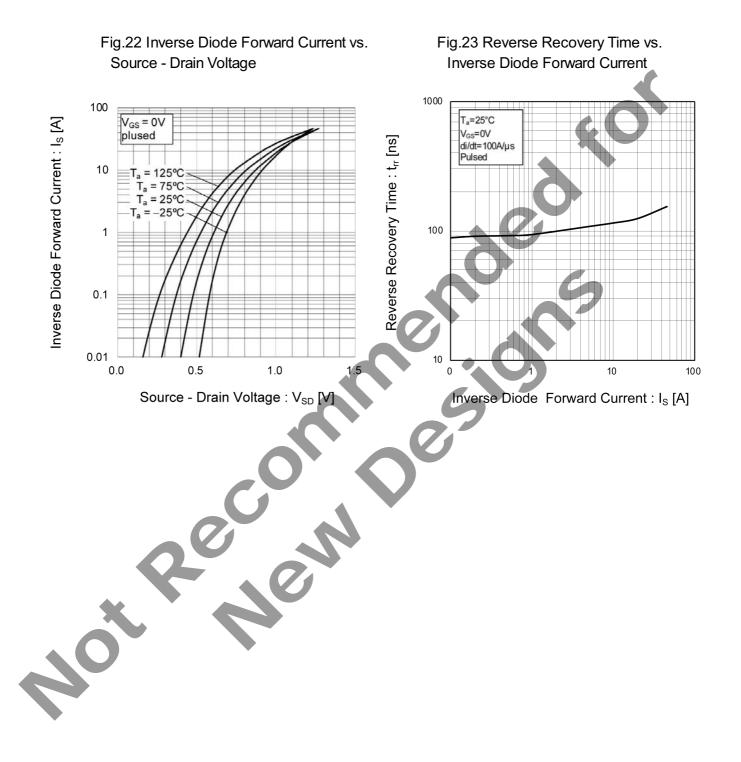






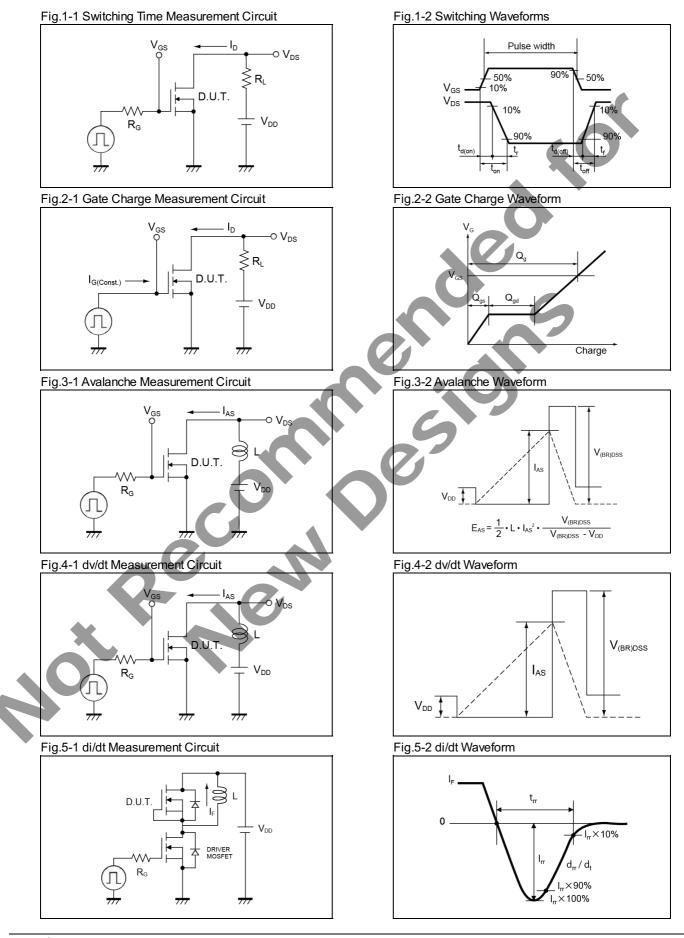






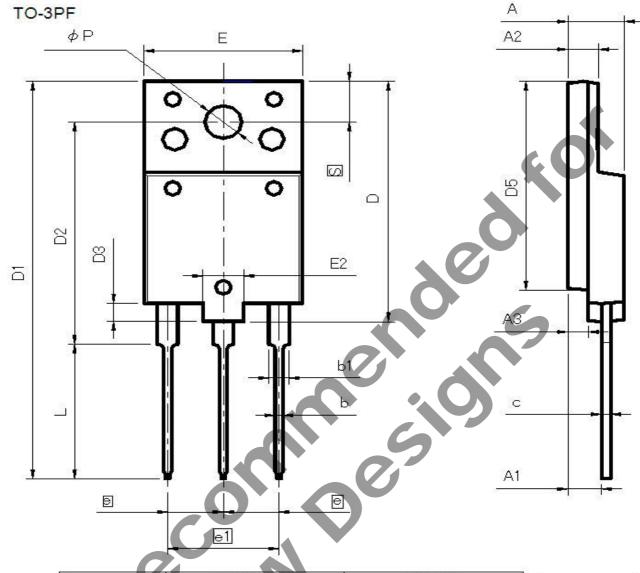


#### Measurement circuits





## Dimensions



	0114	MILIME	TERS	INC	HES	1 г
	DIM	MIN	MAX	MIN	MAX	
	A	5.30	5.70	0.209	0.224	
35	AT	3 10	3.50	0.122	0.138	
	AZ	2.80	3.20	0.11	0.126	
	A3	1.80	2.20	0.071	0.087	
	b	0.65	0.95	0.026	0.037	
	b1	1.80	2.20	0.071	0.087	
	C	0.80	1.10	0.031	0.043	
	D	26.30	26.70	1.035	1.051	
	D1	43.60	44.00	1,717	1.732	
	D2	24.30	24.70	0.957	0.972	
	D3	1.80	2.20	0.071	0.087	
	D4	9.80	10.20	0.386	0.402	ť.
	D5	22.80	23.20	0.898	0.913	i.
	E	15.30	15.70	0.602	0.618	
	e	5.15	5.75	0.203	0.226	
24	e1	10.60	11.20	0.417	0.441	1
	N	3	ê ]		3	i.
.)	L	14.60	15.00	0.575	0.591	
	φP	3.40	3.80	0.134	0.15	
	S	4.30	4.70	0.169	0.185	1



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- 4. The Products are not subject to radiation-proof design.
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De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

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- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

#### Precautions Regarding Application Examples and External Circuits

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This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
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- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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